



BTM410/411 DATA MODULE

Datasheet

Version 6.4



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www.lairdtech.com/bluetooth

REVISION HISTORY

Revision	Date	Description	Approved By
1.0	1 March 2012	Initial Release	Jonathan kaye
2.0	12 March 2012	General updates and compliant with firmware v16.1.3.0	Jonathan kaye
3.0	13 April 2012	Reformatting and general edits	Jonathan kaye
4.0	15 August 2012	Reformatting. Addition of Table 2-6. Reference to Table 2-6 in Table 2-1. Update to Sniff Mode section (everything following Figure 5). Cross References. Updated ATI Commands table. Added links to Low Power and Absolute Current Ratings application notes.	Jonathan kaye
5.0	21 March 2013	Updated mechanical drawings, updated FCC statements, general formatting edits.	Jonathan kaye
6.0	16 January 2014	Separated document into two documents: Hardware Integration Guide and User Guide	Jonathan kaye
6.1	06 Feb 2014	Added the Bluetooth SIG Qualification section.	Jonathan kaye
6.2	07 August 2014	Updated shipping tray image and added module package dimension image.	Jonathan kaye
6.3	3 Sept. 2014	Updated EU Declaration of Conformity	Jonathan kaye
6.4	20 Nov 2016	Updated to Datasheet from Hardware Integration Guide	Sue White

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1 OVERVIEW AND KEY FEATURES

The BTM410 and BTM411 Bluetooth® modules from Laird are designed to meet the needs of developers who wish to add robust, short range Bluetooth data connectivity to their products. These modules are based on the market leading Cambridge Silicon Radio BC04 chipset, providing exceptionally low power consumption with outstanding range. They support the Bluetooth® version 2.1 specification, providing the important advantage of Secure Simple Pairing (SSP), which improves security and ease of use for end customers.

With physical sizes as small as 12.5 mm x 18.0 mm and best of class, low-power operation, these modules are the ideal choice for applications where designers need both performance and minimum size. For maximum flexibility in systems integration, the modules are designed to support a separate power supply for I/O.

To aid product development and integration, Laird has integrated a complete Bluetooth protocol stack within the modules, including support for the Bluetooth Serial Port Profile. The modules are fully qualified as Bluetooth End Products, allowing designers to integrate them within their own products with no further Bluetooth Qualification. They can then list and promote products on the Bluetooth website free of charge.

A comprehensive AT command interface is included, which simplifies firmware integration. Combined with a low cost developer's kit, choosing Laird Bluetooth modules guarantees the fastest route to market.

Features and Benefits



- Bluetooth® v2.1+EDR
- Adaptive Frequency Hopping to handle interference from other wireless devices
- Secure Simple Pairing (SSP) support
- External or internal antenna options
- Comprehensive AT interface for simple programming
- Bluetooth® End Product Qualified
- Compact size
- Class 2 output – 4 dBm
- Low power operation
- UART interface
- PCM and SCO for external codec
- GPIO lines under AT control
- Wi-Fi co-existence

Applications

- Embedded devices
- Phone accessories
- Security devices
- Medical and wellness devices
- Automotive applications
- Bluetooth advertising
- ePOS

2 SPECIFICATIONS

2.1 Detailed Specifications

Table 2-1: Detailed specifications

Categories	Feature	Implementation
Wireless Specification	Bluetooth®	Version 2.1+EDR
	Transmit Class	Class 2
	Frequency	2.402 – 2.480 GHz
	Channels	79 channels Frequency Hopping Adaptive Frequency Hopping
	Max. Transmit Power	+4 dBm at antenna pad – BTM410 +4 dBm from integrated antenna – BTM411
	Min. Transmit Power	-27 dBm at antenna pad – BTM410 -27 dBm from integrated antenna – BTM411
	Receive Sensitivity	-84 dBm
	Range	30 m
	Data Transfer Rate	Up to 300 kbps
	Antenna Modes	External Antenna
Integrated Antenna (option)		+0 dBi multilayer ceramic – BTM411
UART Interface	Serial Interface	RS-232 bi-directional for commands and data 16550 compatible
	Baud Rate	Configurable from 1,200 to 921,600 bps Non-standard baud rates supported
	Bits	8
	Parity	Odd, even, none
	Stop bits	1 or 2
	Default Serial parameters	9600,n,8,1
	Levels	Set by VDD_USB input
	Modem Control	DTR, DSR, DCD, RI, RTS, CTS
General Purpose Interface	I/O	8 general purpose I/O pins
Audio	Support	1 PCM channel @ 64 kbps
	SCO Channels	Support SCO and eSCO

Categories	Feature	Implementation
	PCM Interface	Configurable as master or slave 8 bit A-law 8 bit μ -law 13 bit linear PCM Clock available when in slave mode
Protocols And Firmware	Bluetooth Stack	Version 2.1 compliant. Fully integrated.
	Profiles	GAP (Generic Access Profile) SDP (Service Discovery Profile) SPP (Serial Port Profile)
	Firmware Upgrade	Available over UART
	Connection Modes	Point to point (cable replacement)
Command Interface	AT Instructions set	Comprehensive control of connection and module operation S Registers for non-volatile storage of parameters
Current Consumption	Data Transfer	Typically 32 mA Note: For an Absolute Current Ratings summary, see Table 2-6 .
	Low Power Sniff Mode	Less than 2.5mA
Supply Voltage	Supply	3.0 V – 3.3 V DC
	I/O	1.7 V – 3.3 V DC (independent of Supply)
	USB & UART	1.7 V – 3.6 V DC (independent of Supply)
Coexistence/ Compatibility	WLAN (802.11)	2-wire and 3-wire hardware coexistence schemes supported
Connections	Interface	Surface Mount Pads
	External Antenna (BTM410)	Pad for 50 Ohm antenna
Physical	Dimensions	12.5 mm x 18.0 mm x 3.4 mm BTM410 12.5 mm x 22.0 mm x 3.4 mm BTM411
	Weight	3 grams
Environmental	Operating Temperature	-40° C to +85° C
	Storage Temperature	-40° C to +85° C
Approvals	Bluetooth	Qualified as an Bluetooth End product
	FCC	Limited Modular Approval (BTM410) Full Modular Approval (BTM411)
	CE & R&TTE	Meets CE and R&TTE requirements
Miscellaneous	Lead free	Lead-free and RoHS compliant
	Warranty	1-Year Warranty
Development Tools	Development Kit	Development board and software tools DVK-BTM410 Dev Kit with BTM410 module DVK-BTM411 Dev Kit with BTM411 module

2.2 Pin Definitions

Table 2-2: Pin definitions

Pin #	Signal	Description	Voltage Specification
1	Unused		
2	GND		
3	UART_CTS	Clear to Send I/P	VUSB
4	UART_RXD	Receive data I/P	VUSB
5	UART_RTS	Request to Send O/P	VUSB
6	UART_TXD	Transmit data O/P	VUSB
7	GND		
8	SPI_CSB	SPI bus chip select I/P	VIO
9	SPI_MISO	SPI bus serial O/P	VIO
10	SPI_MOSI	SPI bus serial I/P	VIO
11	SPI_CLK	SPI bus clock I/P	VIO
12	VDD_USB	USB & UART supply voltage	
13	VDD_IO	I/O supply voltage	
14	VDD_IN	Main supply voltage	
15	GND		
16	PCM_IN	PCM data I/P	VIO
17	PCM_SYNC	PCM sync I/P	VIO
18	PCM_CLK	PCM clock I/P	VIO
19	PCM_OUT	PCM data O/P	VIO
20	RESET	Module reset I/P	See note 2
21	GPIO4	I/O for host - BT_Active / BT_State	VIO
22	GPIO2 / UART_DCD	I/O for host	VIO
23	GND		
24	Unused		
25	Unused		See note 3
26	Unused		See note 3
27	Unused		See note 3
28	GND (BTM410 only)		See note 3
29	ANT (BTM410 only)	Antenna connection (50 ohm matched)	See note 3
30	GND (BTM410 only)		See note 3
31	Unused		See note 3
32	Unused		See note 3
33	Unused		See note 3
34	Unused		See note 3
35	Unused		See note 3
36	Unused		See note 3
37	Unused		See note 3
38	Unused		

Pin #	Signal	Description	Voltage Specification
39	Unused		
40	Unused		
41	GND		
42	GPIO1 / UART_RI	I/O for host	VIO
43	GPIO7 / UART_DTR	I/O for host	VIO
44	GPIO8 / UART_DSR	I/O for host	VIO
45	GND		
46	D-	Not used for AT module variants	VUSB
47	D+	Not used for AT module variants	VUSB
48	GPIO6	I/O for host - RF_Active	VIO
49	GPIO5	I/O for host - WLAN_Active	VIO
50	GPIO3	I/O for host - BT_Priority	VIO

1. Unused pins may have internal connections and must not be connected.
2. Reset input is active low. Input is pulled up to VDD_IN via 22k. Minimum reset pulse width is 5 ms.
3. Pins 8 – 11 (SPI related) are only for Laird internal production purposes.
4. Pins 25-37 should be left not connected on modules with integrated antenna.

2.3 Operating Parameters

Table 2-3: Operating parameters

Operating Condition	Min	Max
VDD_USB (USB compatibility not required)	1.7	3.6
VDD_USB (USB compatibility required)	3.1	3.6
VDD_IO	1.7	3.3
VDD_IN	3.0	3.3

2.4 Voltage Specifications

Table 2-4: Voltage specifications (VUSB)

	Min	Typ	Max
Input Voltage Levels			
Vih	0.7VDD_USB		
Vil 2.7<VDD_USB<3.0	-0.4		+0.8
1.7<VDD_USB<1.9	-0.4		-0.4
Output Voltage Levels (1.7<VDD_USB<1.9)			
Voh (Iout = -4mA)	VDD_USB – 0.4		
Vol (Iout = 4mA)			0.4
Output Voltage Levels (2.7<VDD_USB<3.0)			
Voh (Iout = -4mA)	VDD_USB – 0.2		
Vol (Iout = 4mA)			0.2

Note: VDD_USB must be connected to power the USB and UART interfaces.

Table 2-5: Voltage specifications (VIO)

	Min	Typ	Max
Input Voltage Levels			
Vih	0.7VDD_IO		
Vil 2.7<VDD_USB<3.0	-0.4		+0.8
1.7<VDD_USB<1.9	-0.4		-0.4
Output Voltage Levels (1.7 < VDD_IO < 1.9)			
Voh (Iout = -4 mA)	VDD_USB – 0.4		
Vol (Iout = 4 mA)			0.4
Output Voltage Levels (2.7 < VDD_IO < 3.0)			
Voh (Iout = -4 mA)	VDD_USB – 0.2		
Vol (Iout = 4 mA)			0.2

Table 2-6: Absolute Current Rating Summary

Power up / reset	I_avg_reset	20.7 mA	
	t_reset_current_dur.	3.0 s	
Idle ⁽²⁾	I_avg @ 9600 baud	2.60 mA	5 second average, no data at UART ⁽²⁾
	I_avg @ 38400 baud	2.75 mA	
	I_avg @ 115200 baud	2.95 mA	
	I_avg @ 460800 baud	4.37 mA	
Connectable and Discoverable	I_avg_cycle	23.1 mA	AT+BTP / ATS512=4, 9600 Baud, average over 1 interval
Inquiry	I_avg_inquiry	42.1 mA	
Initiate pairing	I_avg_pair_ini	28.8 mA	
Accept pairing	I_avg_pair_acc	42.0 mA	
Initiate a connection (SPP)	I_avg_connect_ini	39.8 mA	
Accept a connection (SPP)	I_avg_connect_ini	37.2 mA	
Connected as master, no data exchange	I_avg_conn_master_idle	13.3 mA	Active mode
	I_avg_master_sniff_idle	13.6 mA	Sniff interval=50 ms
	I_avg_master_ssr_idle	9.9 mA	SSR, interval=300 ms
Connected as slave, no data exchange	I_avg_conn_slave_idle	29.0 mA	Active mode
	I_avg_slave_sniff_idle	12.7 mA	Sniff interval=50 ms
	I_avg_slave_ssr_idle	9.9 mA	SSR, interval=300 ms

1. All current peaks measured were less than 86 mA.
2. Even when no data transmits, higher baud rates cause a higher standby current.
3. For additional information on Absolute Current Rating, see *Application Note – BTM41x Absolute Current Ratings* located at www.lairdtech.com/wireless.

3 FCC REGULATORY STATEMENTS

3.1 BTM410 FCC and Industry Canada Statements

The Final Equipment user manual must show the following statements:

This device complies with part 15 of the FCC Rules. Operation is subject to the following two conditions: (1) This device may not cause harmful interference, and (2) this device must accept any interference received, including interference that may cause undesired operation.

Changes or modifications not expressly approved by the party responsible for compliance could void the user's authority to operate the equipment.

To comply with the FCC RF exposure compliance requirements, this device and its antenna must not be co-located or operating to conjunction with any other antenna or transmitter.

3.1.1 Considerations for OEM Integration

This module has a limited modular approval. Approval with any other antenna configuration or layout other than that approved will necessitate additional radiated emission testing to be performed.

To inherit the modular approval, the antennas for this transmitter must be installed to provide a separation distance of at least 20 cm from all persons and must not be co-located or operating in conjunction with any other antenna or transmitter.

This module was approved with the following antenna:

RF Solutions: ANT-24G-WHJ-SMA 0dBi

Operation of this module with any other antenna will require additional testing to be performed.

Co-location with other radio transmitting devices operating concurrently in the same band will require additional testing and certification.

Designers should note the distinction that the FCC makes regarding portable and mobile devices. Mobile devices are defined as products that are not used closer than 20cm to the human body, whereas portable devices can be used closer than 20cm to the body. A device may be used in portable exposure conditions with no restrictions on host platforms when the averaged output power is less than the low power threshold for an uncontrolled environment $\leq 60/f(\text{GHz})$ i.e. 25mW for a 2.4Ghz device. The Maximum Power Exposure for the BTM410 has been evaluated and found to comply with the low power threshold for an uncontrolled environment.

Refer to FCC document KDB 447498 for more information on RF exposure procedures and equipment authorization policies for mobile and portable devices.

3.1.2 FCC Labelling Requirement

If the FCC ID is not visible when the module is installed inside another device, then the outside of the device into which the module is installed must also display a label referring to the enclosed module. This exterior label can use wording such as the following: "Contains Transmitter Module FCC ID: PI4410B" or "Contains FCC ID: PI4410B." Any similar wording that expresses the same meaning may be used.

3.2 BTM411 FCC and Industry Canada Statements

The user manual must show the following statements:

This device complies with part 15 of the FCC Rules. Operation is subject to the following two conditions: (1) This device may not cause harmful interference, and (2) this device must accept any interference received, including interference that may cause undesired operation.

Changes or modifications not expressly approved by the party responsible for compliance could void the user's authority to operate the equipment.

To comply with the FCC RF exposure compliance requirements, this device and its antenna must not be co-located or operating to conjunction with any other antenna or transmitter.

3.2.1 Considerations for OEM Integration

To inherit the modular approval, the antennas for this transmitter must be installed to provide a separation distance of at least 20 cm from all persons and must not be co-located or operating in conjunction with any other antenna or transmitter.

Co-location with other radio transmitting devices operating concurrently in the same band will require additional testing and certification.

Designers should note the distinction that the FCC makes regarding portable and mobile devices. Mobile devices are defined as products that are not used closer than 20cm to the human body, whereas portable devices can be used closer than 20cm to the body. A device may be used in portable exposure conditions with no restrictions on host platforms when the averaged output power is less than the low power threshold for an uncontrolled environment $\leq 60/f$ (GHz) i.e. 25 mW for a 2.4 GHz device. The Maximum power Exposure for the BTM411 has been evaluated and found to comply with the low power threshold for an uncontrolled environment.

Refer to FCC document KDB 447498 for more information on RF exposure procedures and equipment authorization policies for mobile and portable devices.

3.2.2 FCC Labelling Requirement

If the FCC ID is not visible when the module is installed inside another device, then the outside of the device into which the module is installed must also display a label referring to the enclosed module. This exterior label can use wording such as the following: "Contains Transmitter Module FCC ID: PI4411B" or "Contains FCC ID: PI4411B." Any similar wording that expresses the same meaning may be used.

4 EU DECLARATION OF CONFORMITY – BTM410 / BTM411

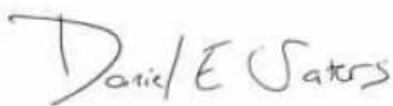
Manufacturer:	Laird
Product:	BTM410 / BTM411 / BTM420 / BTM421 / BTM430 / BTM431 / BTM441 / BTM443 / BTM461
EU Directive:	RTTE 1995/5/EC
Conformity Assessment:	Annex IV

4.1 Reference Standards used for Presumption of Conformity

Article Number	Requirement	Reference standard(s)
3.1a	Health and Safety	EN 60950-1:2005 (2 nd Ed); +Am1:2009 +Am2:2013 EN 60950-1:2006+A11+a1:2010+A12:2011+A2:2013
3.1a	RF Exposure	EN 62479:2010
3.1b	Protection requirements with respect to electromagnetic compatibility	EN 301 489-1 V1.9.2 (2011-09) EN 301 489-17 V2.2.1 (2012-09) Emissions: EN55022:2010 /AC:2011 (ClassB) Immunity: EN61000-4-2:2009 EN61000-4-3:2006 /A1:2008 /A2:2010
3.2	Means of the efficient use of the radio frequency spectrum	EN 300 328 V1.8.1 (2012-06)

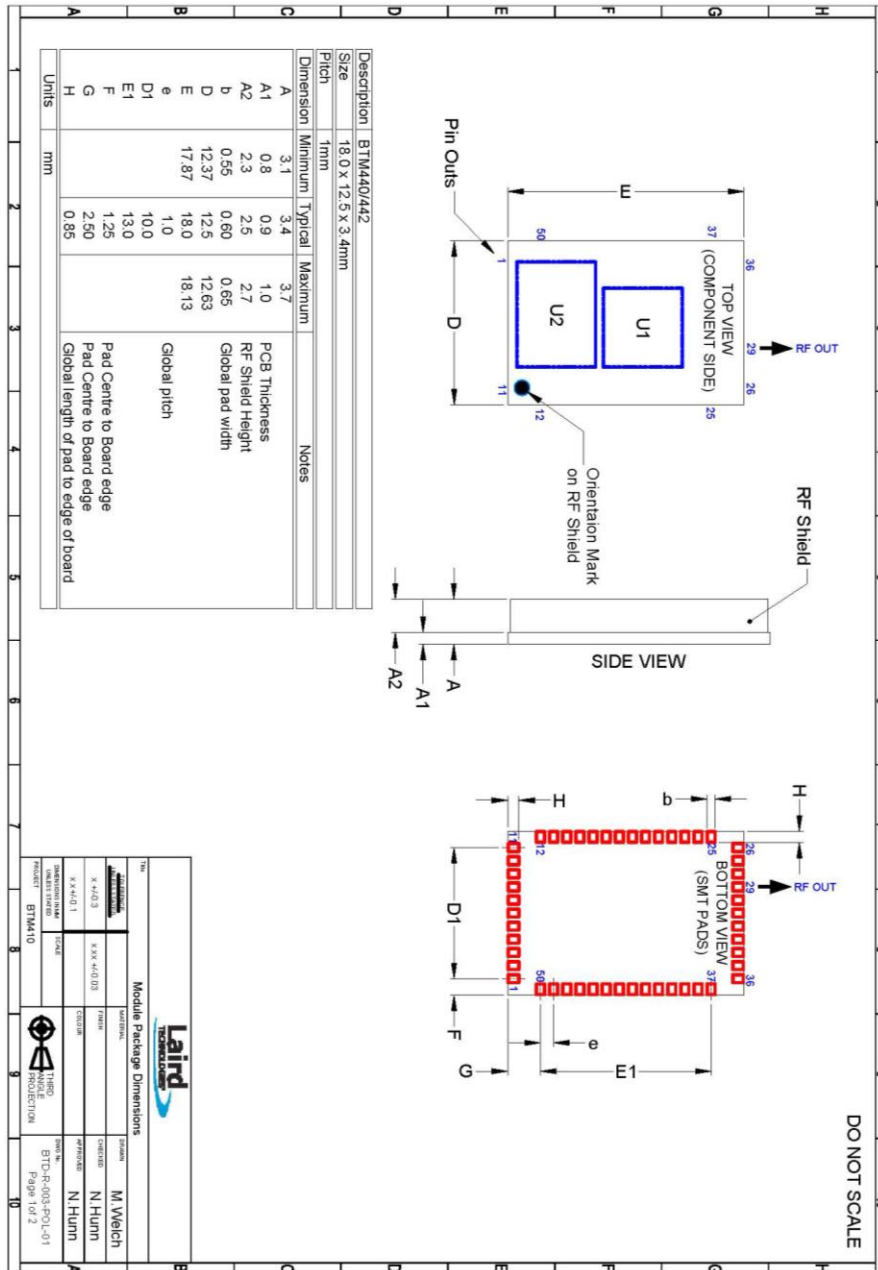
4.2 Declaration:

We, Laird, declare under our sole responsibility that the essential radio test suites have been carried out and that the above product to which this declaration relates is in conformity with all the applicable essential requirements of Article 3 of the EU Directive 1995/5/EC, when used for its intended purpose.

Place of Issue:	Laird 11160 Thompson Ave. Lenexa, KS 66219
Date of Issue:	October 2009
Name of Authorized Person:	Daniel Waters / Certifications Specialist
Signature:	

5 MECHANICAL DRAWINGS

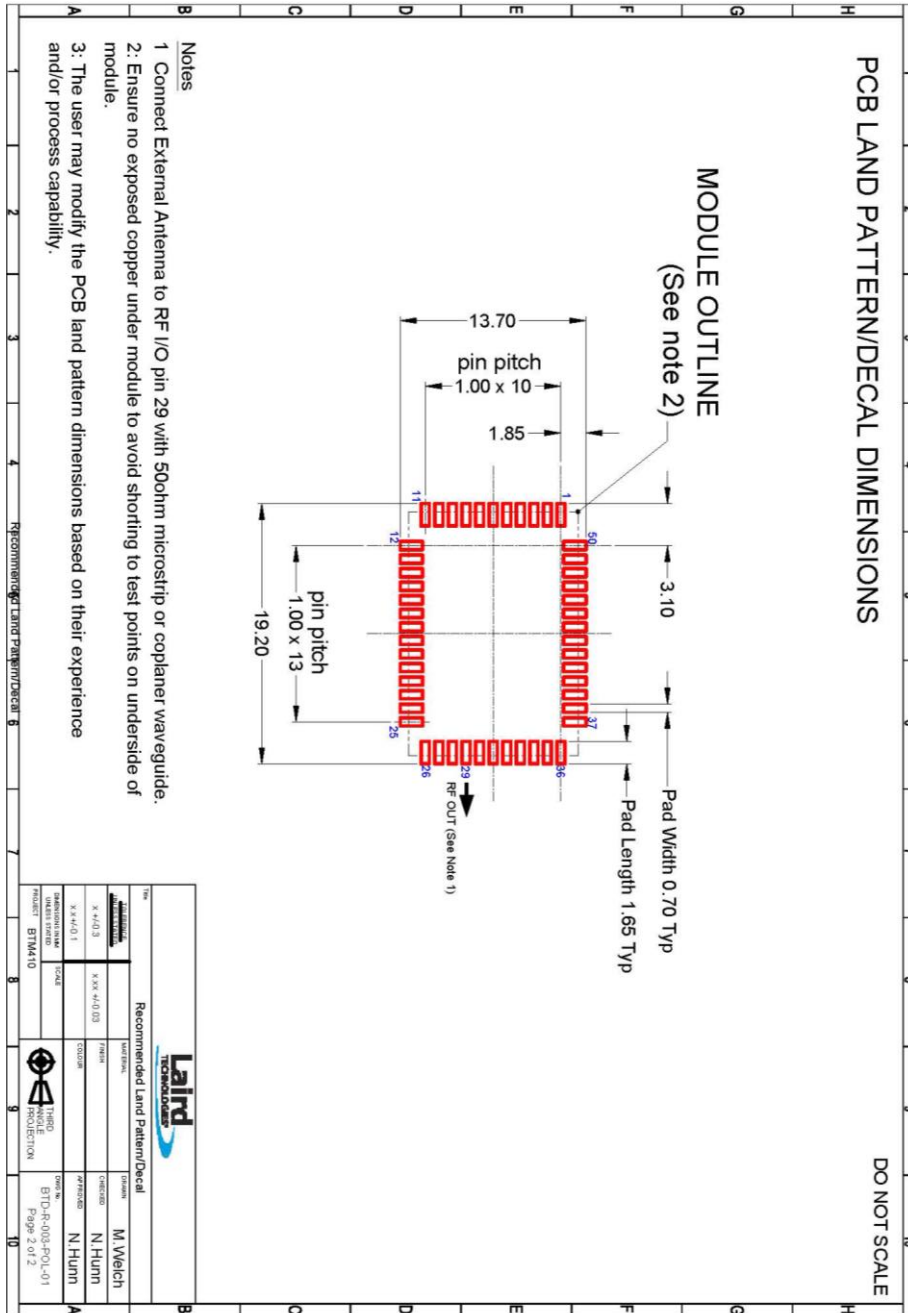
5.1 BTM410 Mechanical Details



Note: An area of 1.5 mm around the module should be reserved as a keep-out area.

Development Kit Schematics can be accessed here: [Development Kit Schematics – BTM410 / BTM411](#)

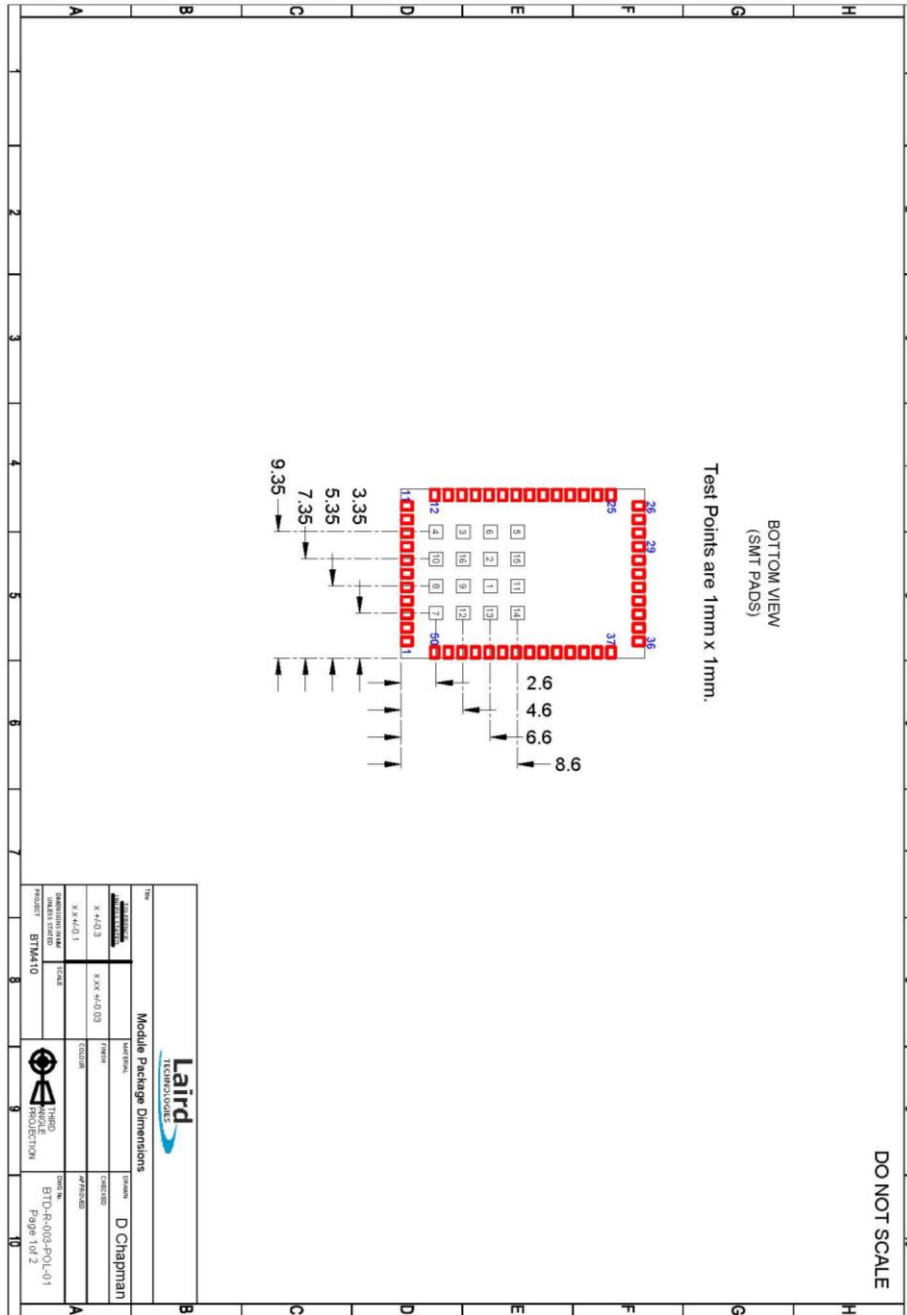
5.2 BTM410 Mechanical Details



Note: An area of 1.5 mm around the module should be reserved as a keep-out area. No other components should be placed in this area.

Development Kit Schematics can be accessed here: [www.lairdtech.com/development-kit-schematics-btm410 / BTM411](http://www.lairdtech.com/development-kit-schematics-btm410-btm411)

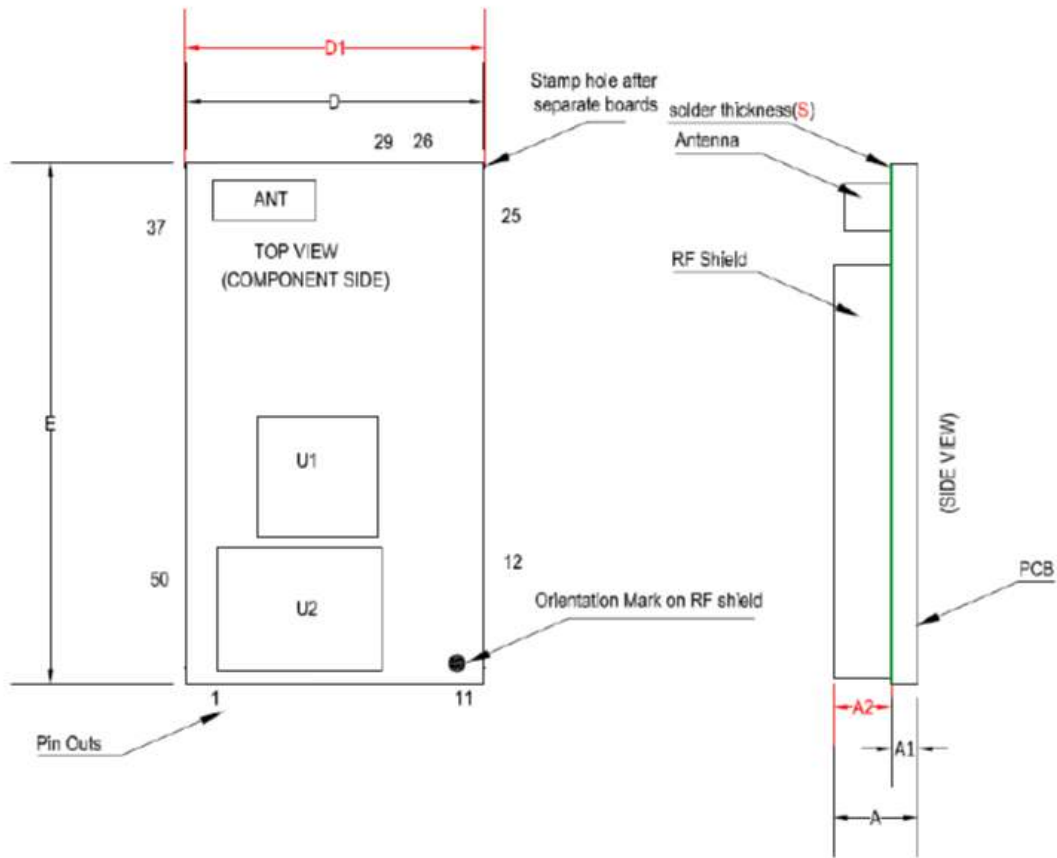
5.3 BTM410 Mechanical Details



WARNING: Test point dimensions are for reference only. *DO NOT* make electrical connections to these test points, this will void the warranty. Laird does not recommend routing on the top layer underneath the module.

Development Kit Schematics can be accessed here: [Development Kit Schematics – BTM410 / BTM411](#)

5.4 BTM411 Mechanical Details

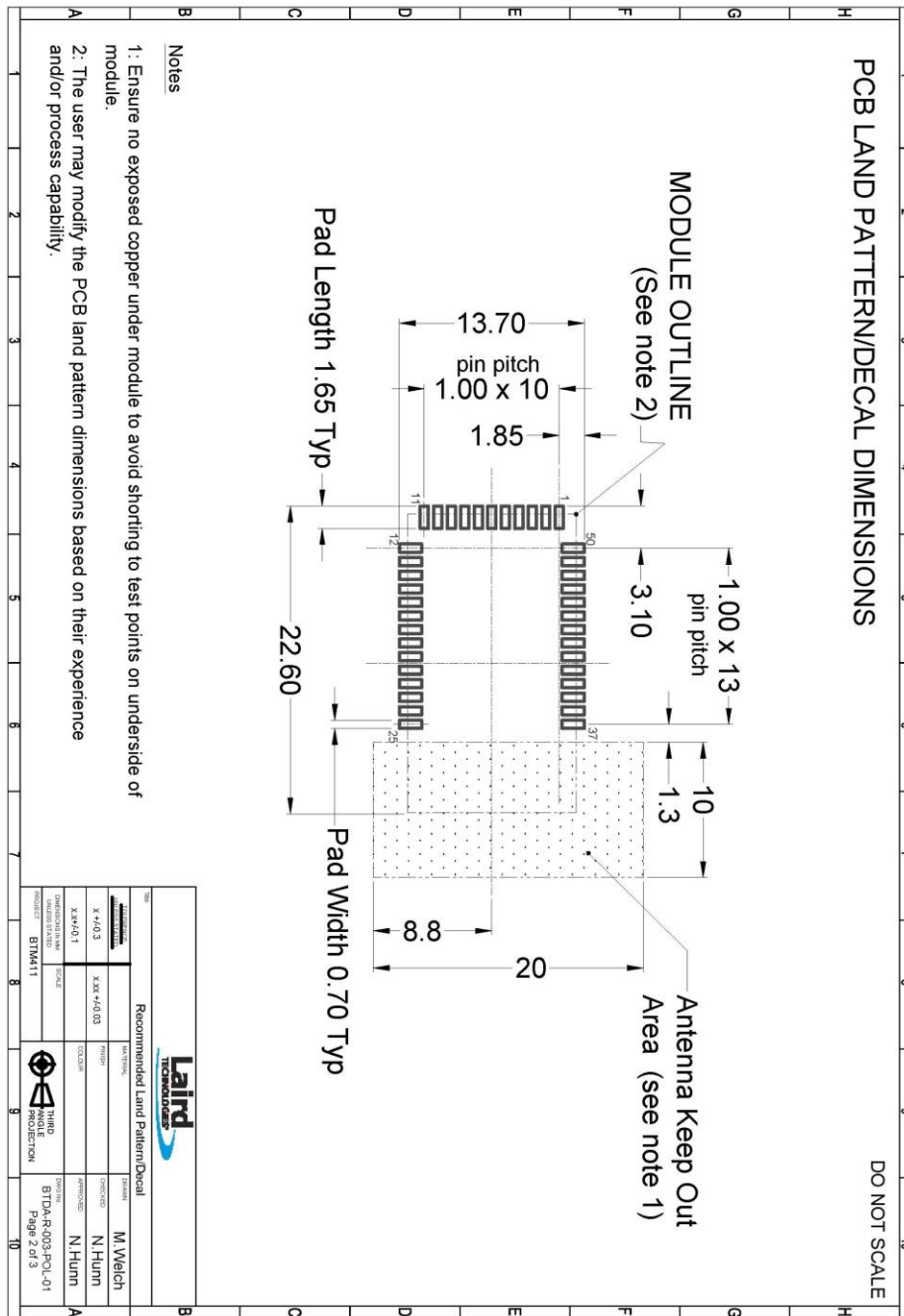


Description	BTM4X1			
Size	22.0x12.5x3.0495mm			
Pitch	1mm			
Dimension	Minimum	Typical	Maximum	Notes
A	2.822mm	3.0495mm	3.277mm	1)A is consist of A1 and A2
A1	0.8mm	0.9mm	1.0mm	2)A2 include solder and shield
A2	2.022mm	2.1495mm	2.277mm	3)D1 measured on stamp hole location after depanelization
D	12.37mm	12.5mm	12.63mm	
D1	12.37mm	12.5mm	13.03mm	
E	21.87mm	22.0mm	22.13mm	

Note: An area of 1.5 mm around the module should be reserved as a keep-out area.

Development Kit Schematics can be accessed here: [Development Kit Schematics – BTM410 / BTM411](#)

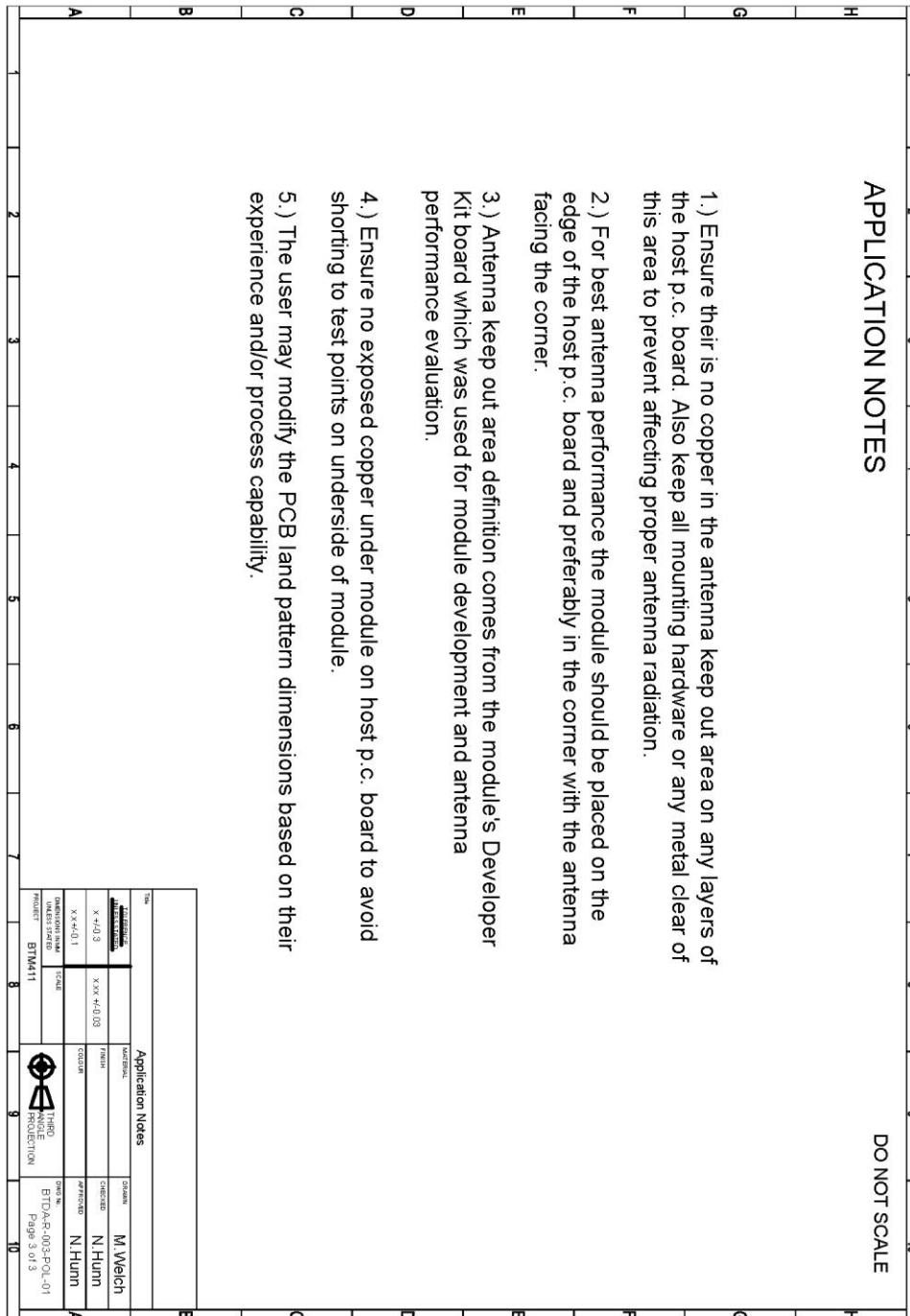
5.5 BTM411 Mechanical Details



Note: An area of 1.5 mm around the module should be reserved as a keep-out area.

Development Kit Schematics can be accessed here: [Development Kit Schematics – BTM410 / BTM411](#)

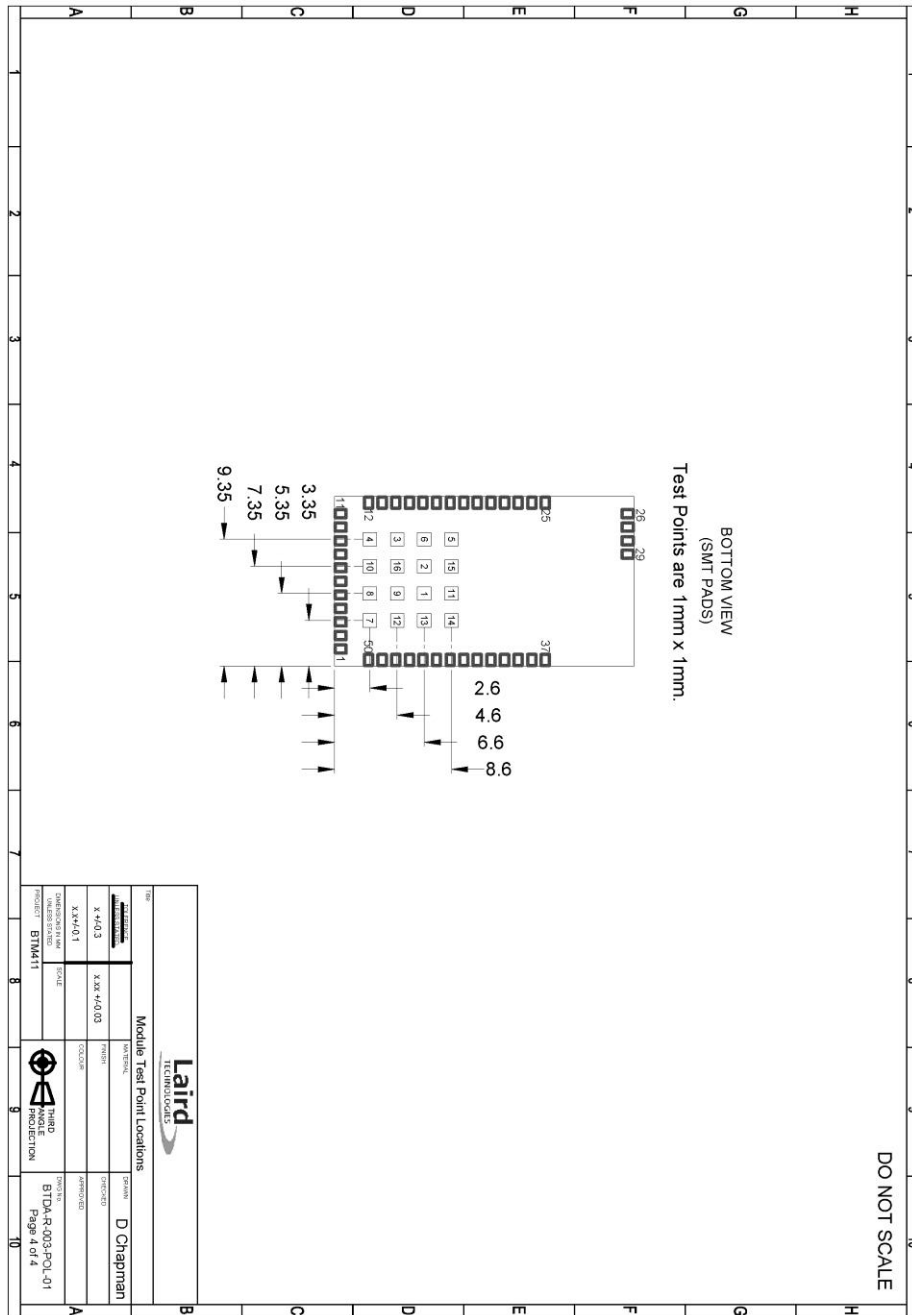
5.6 BTM411 Mechanical Details



Note: An area of 1.5 mm around the module should be reserved as a keep-out area.

Development Kit Schematics can be accessed here: [Development Kit Schematics – BTM410 / BTM411](#)

5.7 BTM411 Mechanical Details



WARNING: Test point dimensions are for reference only. *DO NOT* make electrical connections to these test points, this will void the warranty. Laird does not recommend routing on the top layer underneath the module.

Development Kit Schematics can be accessed here: [Development Kit Schematics – BTM410 / BTM411](#)

6 APPLICATION NOTE FOR SURFACE MOUNT MODULES

6.1 Introduction

Laird's surface mount modules are designed to conform to all major manufacturing guidelines. This section is intended to provide additional guidance beyond the information that is presented elsewhere. This section is considered a living document and will be updated as new information presents.

The modules are designed to meet the needs of several commercial and industrial applications. The modules are designed to be easily manufactured and conform to current automated manufacturing processes.

6.2 Shipping

Modules are shipped in ESD (Electrostatic Discharge) safe trays that can be loaded into most manufacturers pick and place machines. Layouts of the trays are provided in Figure 6-1.

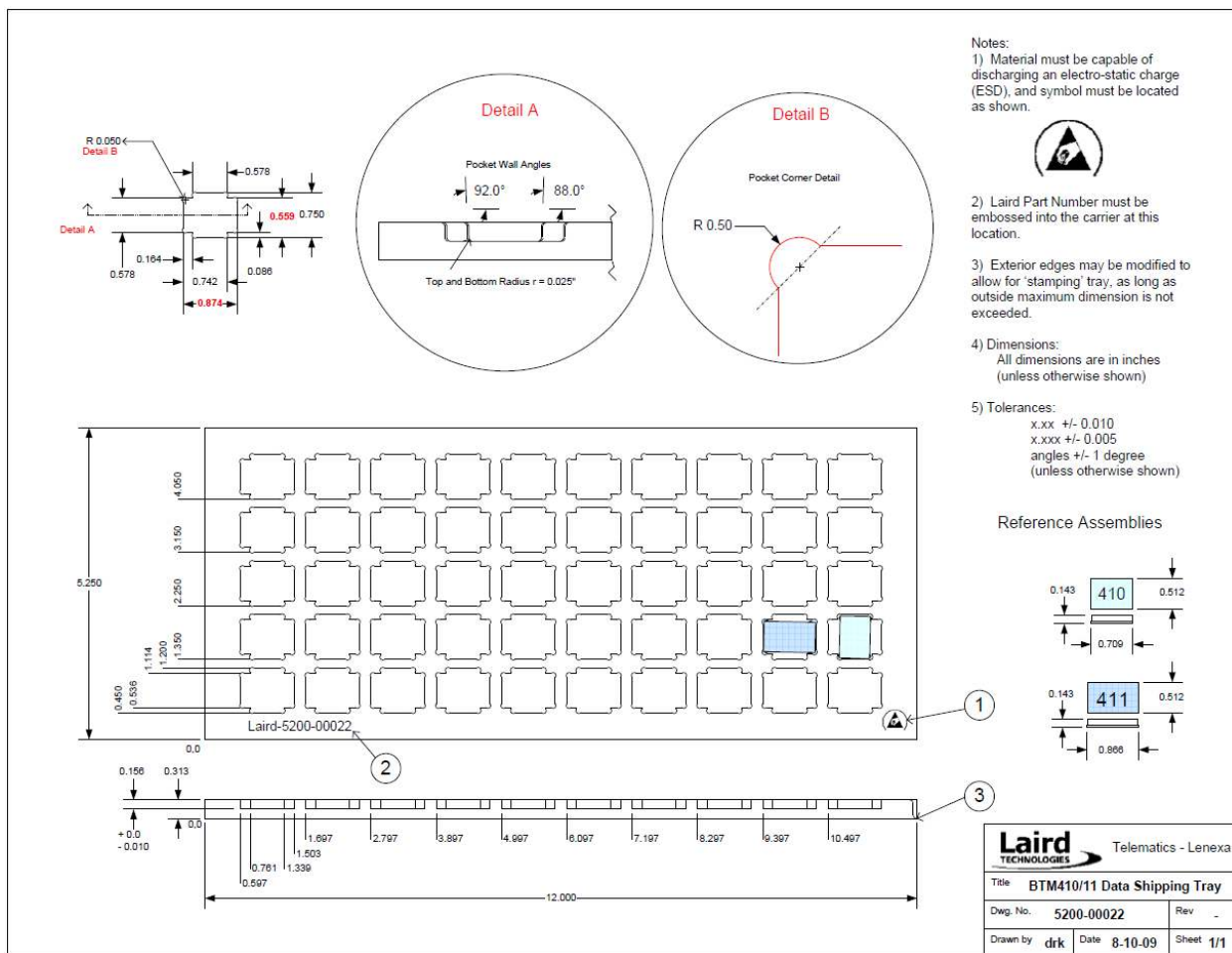


Figure 6-1: BTM410 and BTM411 Shipping Tray Details

6.3 Reflow Parameters

Laird's surface mount modules are designed to be easily manufactured, including reflow soldering to a PCB. Ultimately it is the responsibility of the customer to choose the appropriate solder paste and to ensure oven temperatures during reflow meet the requirements of the solder paste. Laird Technologies' surface mount modules conform to J-STD-020D1 standards for reflow temperatures.

IMPORTANT: During reflow, modules should not be above 260°C and not for more than 30 seconds.

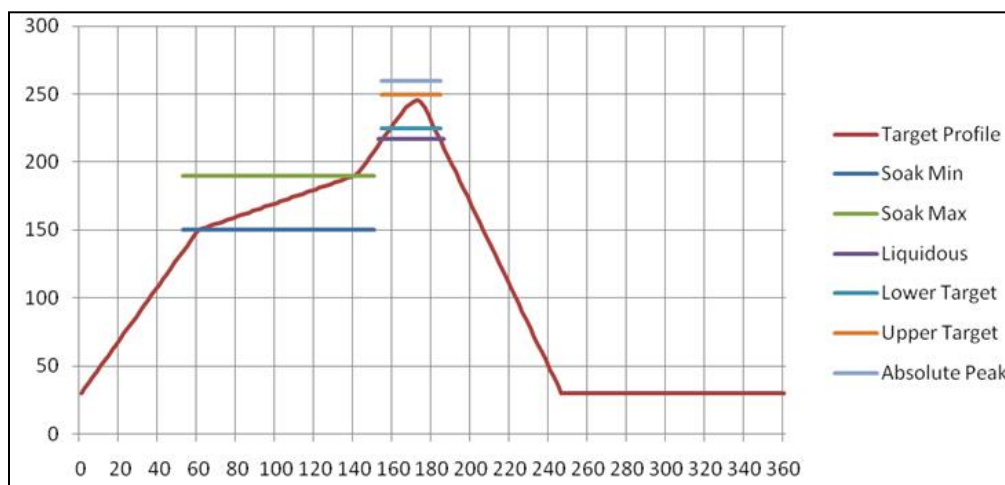


Figure 6-2: Recommended Reflow Temperature

Temperatures should not exceed the minimums or maximums presented in Table 6-1.

Table 6-1: Recommended Maximum and minimum temperatures

Specification	Value	Unit
Temperature Inc./Dec. Rate (max)	3	°C / Sec
Temperature Decrease rate (goal)	2-3	°C / Sec
Soak Temp Increase rate (goal)	.5 - 1	°C / Sec
Flux Soak Period (Min)	60	Sec
Flux Soak Period (Max)	90	Sec
Flux Soak Temp (Min)	150	°C
Flux Soak Temp (max)	190	°C
Time Above Liquidous (max)	60	Sec
Time Above Liquidous (min)	20	Sec

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Specification	Value	Unit
Time In Target Reflow Range (goal)	30	Sec
Time At Absolute Peak (max)	30	Sec
Liquidous Temperature (SAC305)	217	°C
Lower Target Reflow Temperature	225	°C
Upper Target Reflow Temperature	250	°C
Absolute Peak Temperature	260	°C

7 ORDERING INFORMATION

7.1 Product Part Numbers

Part Number	Description
BTM410	Bluetooth AT Data Module (external antenna)
BTM411	Bluetooth AT Data Module (with integrated antenna)
DVK – BTM410	Development board with BTM410 module soldered in place
DVK – BTM411	Development board with BTM411 module soldered in place

7.2 General Comments

Please check with Laird Technologies for the latest information before commencing a design. If in doubt, ask. Refer to the schematic BTMD-R-001.pdf for the Development Kit on the following two pages for examples of typical pin connections. A PDF of the schematic can be downloaded from www.lairdtech.com/wireless.

8 BLUETOOTH SIG QUALIFICATION

The BTM410 and BTM411 modules are listed on the Bluetooth SIG website as qualified End Products.

Design Name	Owner	Declaration ID	Link to listing on the SIG website
BTM410, BTM411	Laird Technologies	B016071	https://www.bluetooth.org/tpg/QLI_viewQDL.cfm?qid=16071

It is a mandatory requirement of the Bluetooth Special Interest Group (SIG) that every product implementing Bluetooth technology has a Declaration ID. Every Bluetooth design is required to

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go through the qualification process, even when referencing a Bluetooth Design that already has its own Declaration ID. The Qualification Process requires each company to registered as a member of the Bluetooth SIG – www.bluetooth.org

The following link provides a link to the Bluetooth Registration page:

<https://www.bluetooth.org/login/register/>

For each Bluetooth Design it is necessary to purchase a Declaration ID. This can be done before starting the new qualification, either through invoicing or credit card payment. The fees for the Declaration ID will depend on your membership status, please refer to the following webpage:

<https://www.bluetooth.org/en-us/test-qualification/qualification-overview/fees>

For a detailed procedure of how to obtain a new Declaration ID for your design, please refer to the following SIG document:

https://www.bluetooth.org/DocMan/handlers/DownloadDoc.ashx?doc_id=283698&vId=317486

To start the listing, go to: https://www.bluetooth.org/tpg/QLI_SDoc.cfm

In step 1, select the option, **Reference a Qualified Design** and enter 16071 in the End Product table entry. You can then select your pre-paid Declaration ID from the drop down menu or go to the Purchase Declaration ID page, (please note that unless the Declaration ID is pre-paid or purchased with a credit card, it will not be possible to proceed until the SIG invoice is paid.

Once all the relevant sections of step 1 are finished, complete steps 2, 3, and 4 as described in the help document. Your new Design will be listed on the SIG website and you can print your Certificate and DoC.

For further information please refer to the following training material:

<https://www.bluetooth.org/en-us/test-qualification/qualification-overview/listing-process-updates>

8.1 Additional Assistance

Please contact your local sales representative or our support team for further assistance:

Laird Technologies Connectivity Products Business Unit

Support Centre: <http://ews-support.lairdtech.com>

Email: wireless.support@lairdtech.com

Phone: Americas: +1-800-492-2320 Option 2

Europe: +44-1628-858-940

Hong Kong: +852 2923 0610

Web: <http://www.lairdtech.com/bluetooth>

BTM410/411

Bluetooth® AT Data Module Datasheet

9 RELATED DOCUMENTS AND FILES

The following additional BTM410/411 technical documents are also available from the Laird BTM41x Series product page under the Documentation tab:

- Product Brief
- User Guide - Version 6.0
- Firmware Release Notes - Version 16.1.3.0
- BTM411 Development Kit Quick Start Guide SPP - Version 2
- Development Kit Schematics
- Quick Start Guide



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<http://ews-support.lairdtech.com>

www.lairdtech.com/bluetooth